

**PATENT ASSIGNMENT**

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<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Mr. Shinichi Ishikawa	02/25/2010
Mr. Kazuhito Tokugawa	02/25/2010
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<b>State/Country:</b>	JAPAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12719832
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OP \$40.00 12719832

# ASSIGNMENT

WHEREAS, I/WE, the Undersigned Inventor(s) have made a certain invention  
entitled: (title) CONTROL APPARATUS FOR INTERNAL COMBUSTION ENGINE

\_\_\_\_\_ filed on (date  
MM/DD/YYYY) MARCH 8, 2010 \_\_\_\_\_, with a Patent

Application No. (if known) 12/719,832 \_\_\_\_\_, for which I/WE have made an  
application for letters patent of the United States of America; and

WHEREAS, (name of corporation) KEIHIN CORPORATION

\_\_\_\_\_ (hereinafter Corporation), a corporation, having its

principal place of business in the (full address) \_\_\_\_\_

26-2, NISHI-SHINJUKU 1- CHOME, SHINJUKU-KU, TOKYO, JAPAN

\_\_\_\_\_ is desirous  
of acquiring an interest therein.

NOW, THEREFORE, in consideration of Ten Dollars (US \$10.00), in  
currency of the United States of America, and other good and valuable  
consideration, the receipt and sufficiency of which is hereby acknowledged,  
I/WE, the Undersigned Inventor(s), by these presents, do sell, assign and  
transfer unto said Corporation, my/our entire right, title and interest, for the  
United States of America and its possessions and territories, and all foreign  
countries, in and to said invention as described and claimed in an application  
for letters patent of the United States of America, preparatory to obtaining

letters patent of the United States of America therefor, said application for letters patent of the United States of America, together with the right to file additional applications for letters patents or other forms of protection for said invention in all foreign countries, including all rights of priority created or conferred by any international convention or treaty to which the United States of America is a party or signatory, and in and to any letters patents or other forms of protection that may be granted for said invention; said invention, applications for patents or other forms of protection and letters patents or other forms of protection, and any continuation, continuations-in-part, divisions, reissues, extensions and renewals thereof, to be held and enjoyed by said Corporation, for its use and behoof and for its legal representatives, successors and assigns, to the full ends of the terms for which said letters patents or other forms of protection may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

For the same consideration, I/WE hereby covenant and agree that I/WE will and that my/our legal representative shall execute and deliver any and all application papers, assignments, powers of attorney and other instruments that said Corporation may consider necessary or advisable to secure letters patents or other forms of protection of the United States of America and all foreign countries for said invention, and any continuations, continuations-in-part, divisions, reissues, extensions and renewals thereof, and to vest and confirm in said Corporation, the full and complete legal and equitable title to said invention, applications and letters patents or other forms of protection, without further consideration than that now paid but at the expense of said Corporation, its successors or assigns.

Full name of sole or first inventor (Last, First, Middle):

ISHIKAWA, Shinichi

Inventor's signature:

Shinichi Ishikawa

Date (MM/DD/YYYY):

February 25, 2010

Address:

c/o Keihin Corporation Tochigi Research & Development Center, 2021-8  
Aza Saginoya-Higashi, Hoshakuji, Takanezawa-machi, Shioya-gun, Tochigi, Japan

Full name of second inventor:

TOKUGAWA, Kazuhito

Inventor's signature:

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Full name of third inventor:

Inventor's signature:

Date (MM/DD/YYYY):

Address:

Full name of fourth inventor:

Inventor's signature:

Date (MM/DD/YYYY):

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